

IGBT Transistors 650V/35A FAST IGBT FSII T



650 V Trench and Fieldstop IGBT

PRODUCT SUMMA	RY	
V _{CE} (V)	65	0
I _C (A)	160 (TC=25℃)	80 (TC=100℃)
VCE (sat) (V)	1.7	7
Ісм (А)	240	0



- Very Low VCEsat
- · Low turn-off losses
- High speed switching
- Maximum junction temperature 175°C
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)

APPLICATIONS

- Telecommunications
- Server and telecom power supplies Lighting
- High-intensity discharge (HID) - Fluorescent ballast lighting
- Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
- Battery chargers Renewable energy
 - Solar (PV inverters)
- Switch mode power supplies (SMPS)

Package pin definition

- Pin1 G Gate
- Pin2 C & backside Collector
- Pin3 E Emitter

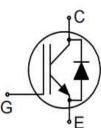
PARAMETER		ess otherwis	SYMBOL	LIMIT	UNIT
Collector-Emitter Voltage				650	
0			V _{CE}		- v
Gate-Emitter Voltage			V _{GE}	±30	
Continuous Collector Current (T _{.1} = 150 $^{\circ}$ C)	V _{GE} at 15 V	T _C = 25 °C T _C = 100 °C		160	
	VGE at 15 V	T _C = 100 °C	IC	80	A
Pulsed Collector Current ^a			I _{CM}	240	7
Diode Forward Current ^b			l _F	80	A
Maximum Power Dissipation		T _C = 25 °C	PD	510	W
		T _C = 100 °C		260	w
Operating Junction and Storage Temperature Rang	e		T _J , T _{stg}	-55 to +175	°C
Short Circuit Withstand Time TC=150°C	VGE= 15V, VCE≤ 400V		taa	3	
Short Circuit Withstand Time TC=100°C	VGE= 15V, V	CE≪330V	tsc –	5	– μs
Soldering Recommendations (Peak Temperature) ^c	for	10 s		260	°C

a. Repetitive rating; pulse width limited by maximum junction temperature.

- b. Current limited by maximum junction temperature.
- c. 1.6 mm from case.



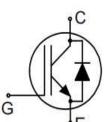
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Top View

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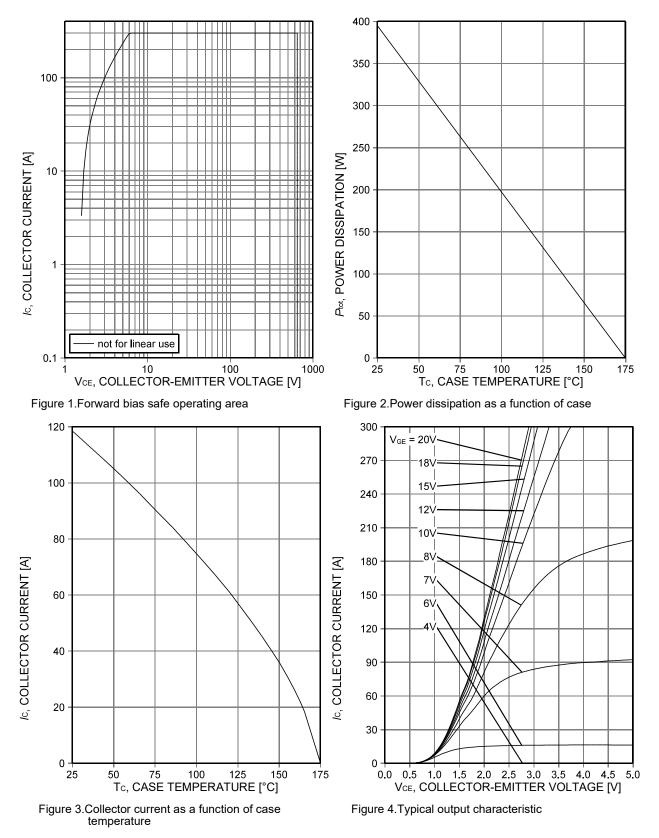




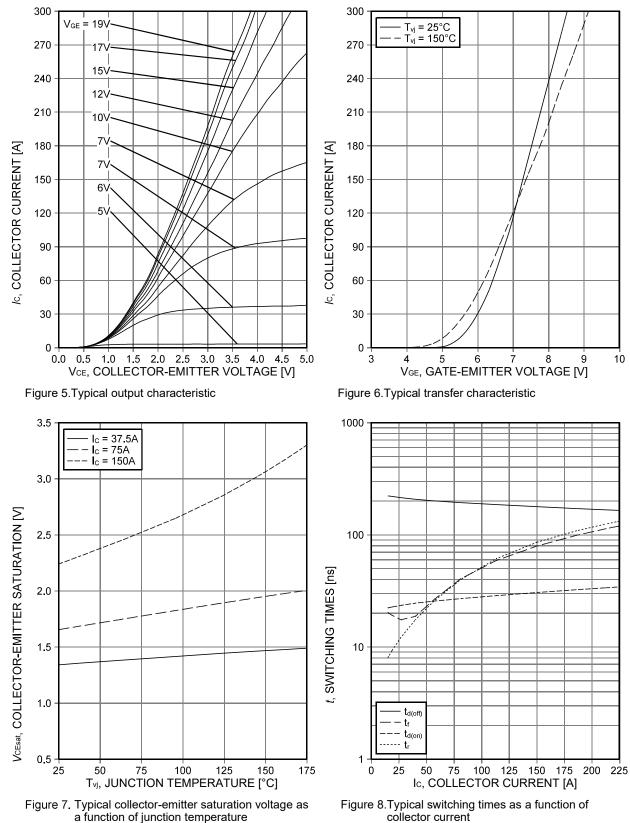
THERMAL RESISTANCE RA	FINGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	40	°C/W
Maximum Junction-to-Case	R _{thJC}	-	0.5	0/10

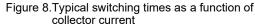
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	•			L			
		V _{GE} :	= 0 V, I _C = 250 μΑ	650	-	-	v
Collector-Emitter Breakdown Voltage	BV _{CE}	VGE	= 0 V, Ic = 1 mA	650	-	-	V
Gate-Source Threshold Voltage (N)	V _{GE(th)}	V _{CE} =	= V _{GE} , I _D = 250 μΑ	4	5	6	V
Zero Gate Voltage Collector Current		V _{CE} = 650 V,	VGE = 0 V,TJ = 25 °C	-	1	20	μA
Zero Gate voltage Collector Current	ICES	VCE = 650 V,	Vge = 0 V,Tj = 150 °C	-	1000	-	μA
Gate-Emitter Leakage Current	I _{GES}	$V_{CE} = 0$	V, $V_{GS} = \pm 2 \ 0 \ V$	-	-	100	nA
Collector-Emitter Saturation Voltage	V _{CE(sat)}	V _{GE} = 15 V	I _C = 80 A	-	1.8	2.1	V
Forward Transconductance	9 _{fs}	V _{CE}	= 20 V, I _C = 80 A	-	40	-	S
Dynamic	•	•		•	•	•	
Input Capacitance	Cies	Var	= 0 V, VCE = 25 V,	-	8400	-	pF
Output Capacitance	C _{oes}] VGE	f = 500 KHz	-	230	-	
Reverse Transfer Capacitance	C _{res}		1 = 000 1112	-	80	-]
Turn-on Energy	E _{on}	$V_{CE} = 400 \text{ V}$, $V_{GE} = 0 / 15 \text{V}$,		-	0.51	-	nJ
Turn-off Energy	Eoff	I _C = 80 A	$A_{g} = 10\Omega$	-	0.18	-	
Total Gate Charge	Qg			-	196	-	
Gate-Emitter Charge	Q _{ge}	V _{GE} = 15 V	I _C = 80 A, V _{CE} = 400 V	-	21	-	nC
Gate to Collector Charge	Q _{gc}			-	23	-	
Turn-On Delay Time	t _{d(on)}			-	80	-	
Rise Time	t _r	$V_{CE} = 400 \text{ V}, \text{ V}_{GE} = 0 / 15 \text{ V},$		-	75	-	- ns
Turn-Off Delay Time	t _{d(off)}	- I _C = 80 A, R _g = 10Ω		-	195	-	
Fall Time	t _f			-	35	-	
Internal emitter inductance measured 5 mm	LE			-	13	-	nH
Diode Characteristics							
Diode Forward Current	١ _F	IGBT symbol showing the integral reverse junction diode		-	-	80	A
Pulsed Diode Forward Current	I _{FM}			-	-	240	
Diode Forward Voltage	V _F		I _F = 80 A	-	1.42	2.0	V
Reverse Recovery Time	t _{rr}			-	90	-	ns
Reverse Recovery Charge	Q _{rr}		¯ _J = 25 °C, I _F = 80 A, t = 200 A/μs, V _B = 400 V	-	0.15	-	μC
Reverse Recovery Current	I _{BBM}		$r = 200 \text{ PV} \mu \text{s}, \text{ v}_{\text{R}} = 400 \text{ v}$	_	15	-	A



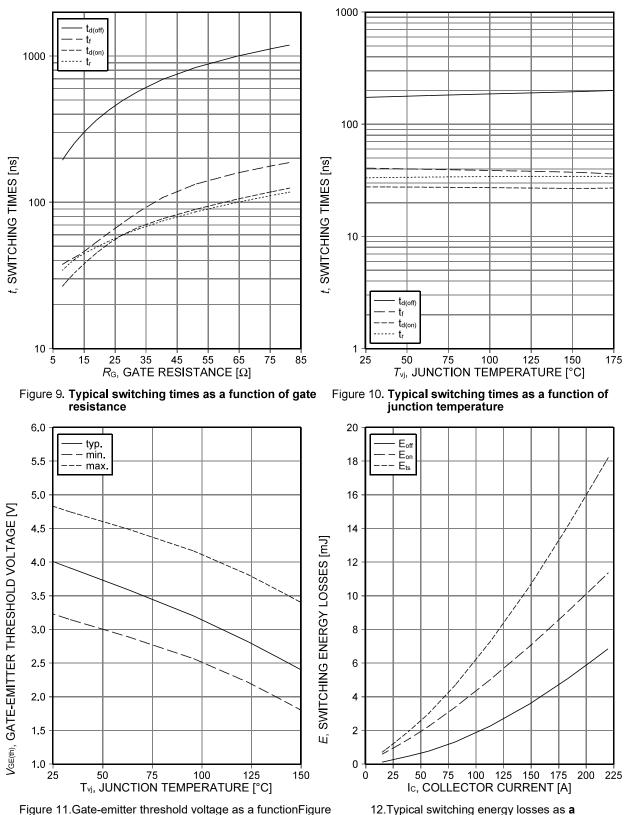










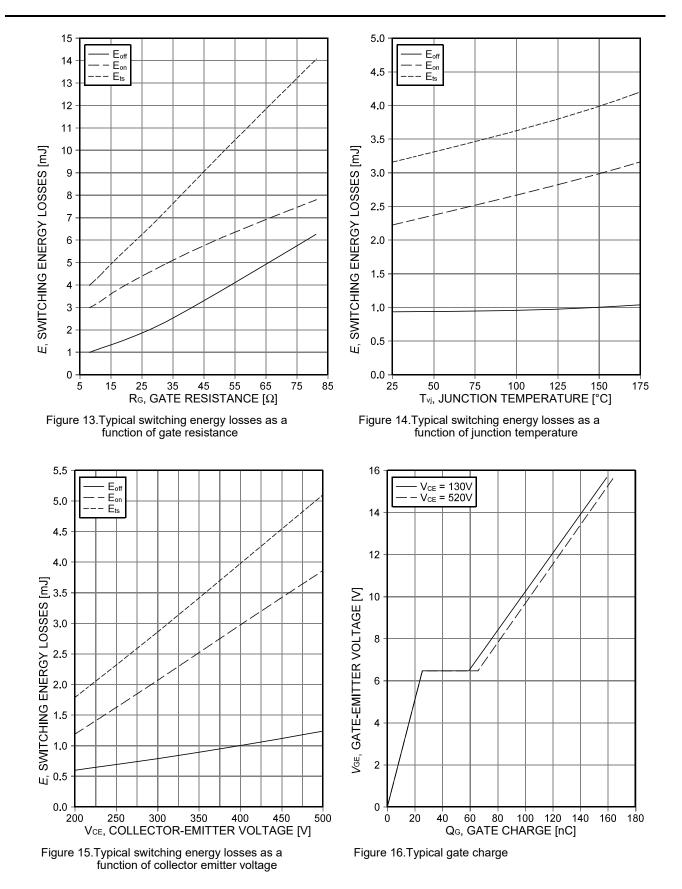


12.Typical switching energy losses as **a** function of collector current

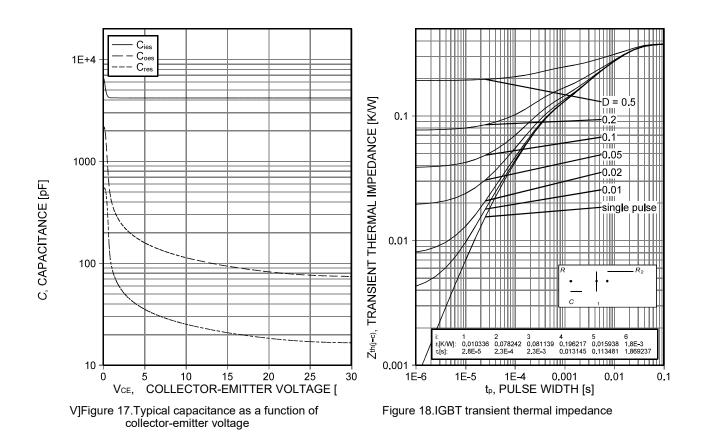
more info: sales@bec.co.uk

of junction temperature



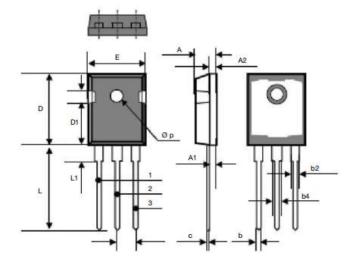








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DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	4.70	5.31	0.185	0.209
A1	2.21	2.59	0.087	0.102
A2	1.50	2.49	0.059	0.098
b	0.99	1.40	0.039	0.055
b2	1.65	2.41	0.065	0.095
b4	2.59	3.43	0.102	0.135
с	0.61 BSC		0.024 BSC	
D	20.80	21.46	0.819	0.845
D1	3.68	5.49	0.145	0.216
(e)	5.46 BSC		0.215	BSC
E	15.49	16.26	0.610	0.640
L	19.81	20.32	0.780	0.800
L1	4.06	4.50	0.160	0.177
Øp	3.51	3.66	0.138	0.144